TE Internal #: 1-1761465-1

PCI & PCI Express Connectors, Board-to-Board, 36 Position, .039 in

[1 mm] Centerline, Right Angle, Black, Height .37 in [9.4 mm]

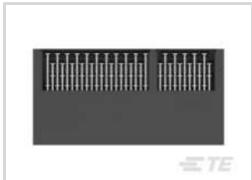
View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors











Connector System: Board-to-Board

Number of Positions: 36

Centerline (Pitch): 1 mm [ .039 in ]

Termination Post & Tail Length: 3.1 mm [.122 in]

Contact Mating Area Plating Material Thickness: [30 µin]

#### **Features**

#### **Product Type Features**

Connector System	Board-to-Board
Sealable	No
Sediable	INO
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of PCB Mount Retention Features	2
Number of Positions	36
PCB Mount Orientation	Right Angle
Ejector	Without
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	

Product Weight

Primary Product Color

Contact Mating Area Plating Material Gold

21.302 g

Black



Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
	30 μin
Contact Current Rating (Max)	1.1 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Post & Tail Length	3.1 mm[.122 in]
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Nylon
	1 [020: ]
Centerline (Pitch)	1 mm[.039 in]
Centerline (Pitch)  Dimensions	T mm[.U39 in]
	1.57 mm[.062 in]
Dimensions	
Dimensions  PCB Thickness (Accepted)	1.57 mm[.062 in]
Dimensions  PCB Thickness (Accepted)  Connector Height	1.57 mm[.062 in] 9.4 mm[.37 in]
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width	1.57 mm[.062 in] 9.4 mm[.37 in]
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width  Usage Conditions	1.57 mm[.062 in] 9.4 mm[.37 in] 19.6 mm[.772 in]
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width  Usage Conditions  Operating Temperature Range	1.57 mm[.062 in] 9.4 mm[.37 in] 19.6 mm[.772 in]
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width  Usage Conditions  Operating Temperature Range  Operation/Application	1.57 mm[.062 in] 9.4 mm[.37 in] 19.6 mm[.772 in] -40 – 85 °C[-40 – 185 °F]
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width  Usage Conditions  Operating Temperature Range  Operation/Application  Circuit Application	1.57 mm[.062 in] 9.4 mm[.37 in] 19.6 mm[.772 in] -40 – 85 °C[-40 – 185 °F]
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width  Usage Conditions  Operating Temperature Range  Operation/Application  Circuit Application  Industry Standards	1.57 mm[.062 in] 9.4 mm[.37 in] 19.6 mm[.772 in]  -40 – 85 °C[-40 – 185 °F]  Signal
Dimensions  PCB Thickness (Accepted)  Connector Height  Connector Width  Usage Conditions  Operating Temperature Range  Operation/Application  Circuit Application  Industry Standards  Bus Type	1.57 mm[.062 in] 9.4 mm[.37 in] 19.6 mm[.772 in]  -40 – 85 °C[-40 – 185 °F]  Signal

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant



China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**





# Customers Also Bought









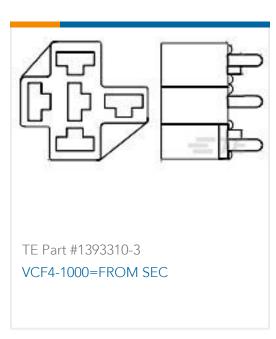














#### **Documents**

#### **Product Drawings**

PCI Express RA assy 5.8mm slot 3.1mm pc

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1-1761465-1\_C.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1761465-1\_C.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1761465-1\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### Datasheets & Catalog Pages

4-1773442-7 Card Edge Connector for PCI Express Applications

English

#### **Product Specifications**

**Application Specification** 

English